# 2.5V 1:5 Dual Differential LVDS Compatible Clock Driver

The MC100EP210S is a low skew 1–to–5 dual differential driver, designed with LVDS clock distribution in mind. The LVDS or LVPECL input signals are differential and the signal is fanned out to five identical differential LVDS outputs.

The EP210S specifically guarantees low output-to-output skew. Optimal design, layout, and processing minimize skew within a device and from device to device.

Two internal 50  $\Omega$  resistors are provided across the inputs. For LVDS inputs, VTA and VTB pins should be unconnected. For LVPECL inputs, VTA and VTB pins should be connected to the V<sub>TT</sub> (V<sub>CC</sub>-2.0 V) supply.

Designers can take advantage of the EP210S performance to distribute low skew LVDS clocks across the backplane or the board.

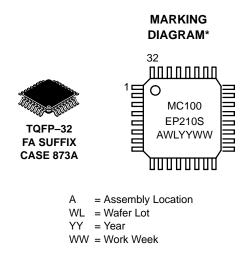
Special considerations are required for differential inputs under No Signal conditions to prevent instability.

- 20 ps Typical Output-to-Output Skew
- 85 ps Typical Device-to-Device Skew
- 550 ps Typical Propagation Delay
- The 100 Series Contains Temperature Compensation
- Maximum Frequency >1 GHz Typical
- Operating Range:  $V_{CC} = 2.375$  V to 2.625 V with  $V_{EE} = 0$  V
- Internal 50  $\Omega$  Input Termination Resistors
- LVDS Input/Output Compatible



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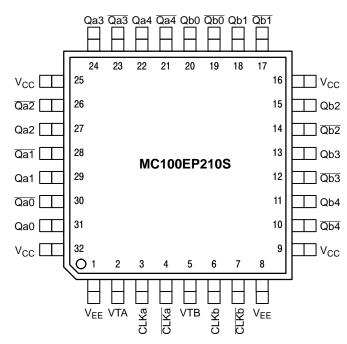
http://onsemi.com



\*For additional information, refer to Application Note AND8002/D

## **ORDERING INFORMATION**

Device	Package	Shipping			
MC100EP210SFA	TQFP–32	250 Units/Tray			
MC100EP210SFAR2	TQFP-32	2000 Tape & Reel			

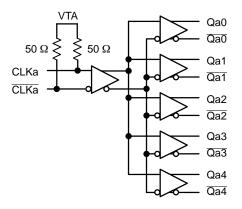


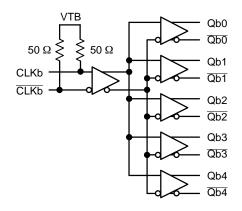
# **PIN DESCRIPTION**

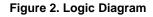
PIN	FUNCTION
CLKn, CLKn	LVDS, LVPECL CLK Inputs
Qn0:4, Qn0:4	LVDS Outputs
VTA	50 Ohm Termination Resistors
VTB	50 Ohm Termination Resistors
V <sub>CC</sub>	Positive Supply
V <sub>EE</sub>	Ground

Warning: All  $V_{CC}$  and  $V_{EE}$  pins must be externally connected to Power Supply to guarantee proper operation.

# Figure 1. 32-Lead TQFP Pinout (Top View)







## ATTRIBUTES

Characteristi	cs	Value
Internal Input Pulldown Resistor		N/A
Internal Input Pullup Resistor		N/A
ESD Protection	Human Body Model Machine Model Charged Device Model	> 2 kV > 100 V > 2 kV
Moisture Sensitivity (Note 1)		Level 2
Flammability Rating Oxygen Index		UL–94 code V–0 A 1/8" 28 to 34
Transistor Count		461 Devices
Meets or exceeds JEDEC Spec EIA/JE	ESD78 IC Latchup Test	

1. For additional information, refer to Application Note AND8003/D.

## MAXIMUM RATINGS (Note 2)

Symbol	Parameter	Condition 1	Condition 2	Rating	Units
V <sub>CC</sub>	Power Supply	$V_{EE} = 0 V$		6	V
$V_{EE}$	Power Supply (GND)	V <sub>CC</sub> = 2.5 V		-6	V
VI	LVDS, LVPECL Input Voltage	V <sub>EE</sub> = 0 V	$V_{I} \leq V_{CC}$	6	V
l <sub>out</sub>	Output Current	Continuous Surge		50 100	mA mA
ТА	Operating Temperature Range			-40 to +85	°C
T <sub>stg</sub>	Storage Temperature Range			-65 to +150	°C
$\theta_{JA}$	Thermal Resistance (Junction to Ambient)	0 LFPM 500 LFPM	32 TQFP 32 TQFP	80 55	°C/W °C/W
$\theta_{\text{JC}}$	Thermal Resistance (Junction to Case)	std bd	32 TQFP	12 to 17	°C/W
T <sub>sol</sub>	Wave Solder	<2 to 3 sec @ 248°C		265	°C

2. Maximum Ratings are those values beyond which device damage may occur.

## DC CHARACTERISTICS V<sub>CC</sub> = 2.5 V, V<sub>EE</sub> = 0 V (Note 3)

		–40°C 25°C		85°C							
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I <sub>EE</sub>	Power Supply Current		150	200		150	200		150	200	mA
V <sub>OH</sub>	Output HIGH Voltage (Note 4)	1250	1400	1550	1250	1400	1550	1250	1400	1550	mV
V <sub>OL</sub>	Output LOW Voltage (Note 4)	800	950	1100	800	950	1100	800	950	1100	mV
VIHCMR	Input HIGH Voltage Common Mode Range (Differential) (Note 5)	1.2		2.5	1.2		2.5	1.2		2.5	V
R <sub>T</sub>	Internal Termination Resistor	43		57	43	50	57	43		57	Ω
I <sub>IH</sub>	Input HIGH Current			150			150			150	μA
I <sub>IL</sub>	Input LOW Current CLK CLK	0.5 -150			0.5 -150			0.5 -150			μA

NOTE: 100EP circuits are designed to meet the DC specifications shown in the above table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained.

3. Input and output parameters vary 1:1 with  $V_{CC}.$  4. All loading with 100 ohms across LVDS differential outputs.

5. VIHCMR min varies 1:1 with VEE, VIHCMR max varies 1:1 with VCC. The VIHCMR range is referenced to the most positive side of the differential input signal.

			-40°C		25°C			85°C			
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
f <sub>maxLVDS/</sub> LVPECL	Maximum Frequency (See Figure 3. F <sub>max</sub> /JITTER)		> 1			> 1			> 1		GHz
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay	425	525	625	450	550	650	475	575	675	ps
t <sub>skew</sub>	Within–Device Skew (Note 7) Device–to–Device Skew (Note 8) Duty Cycle Skew (Note 9)		20 85 80	25 160 100		20 85 80	25 160 100		20 85 80	35 160 100	ps
<sup>†</sup> JITTER	Cycle-to-Cycle Jitter (See Figure 3. F <sub>max</sub> /JITTER)		.2	< 1		.2	< 1		.2	< 1	ps
V <sub>PP</sub>	Minimum Input Swing	150	800	1200	150	800	1200	150	800	1200	mV
t <sub>r</sub> /t <sub>f</sub>	Output Rise/Fall Time (20%-80%)	50	130	200	75	150	225	80	160	230	ps

## AC CHARACTERISTICS $V_{CC}$ = 2.375 to 2.625 V, $V_{EE}$ = 0 V (Note 6)

6. Measured with 400 mV source, 50% duty cycle clock source. All loading with 100 ohms across differential outputs.

7. Skew is measured between outputs under identical transitions of similar paths through a device.

8. Device-to-Device skew for identical transitions at identical V<sub>CC</sub> levels.

9. Duty cycle skew guaranteed only for differential operation measured from the cross point of the input to the cross point of the output.

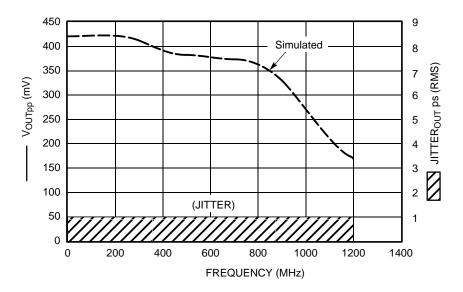


Figure 3. F<sub>max</sub>/Jitter

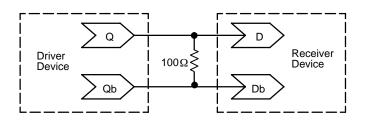
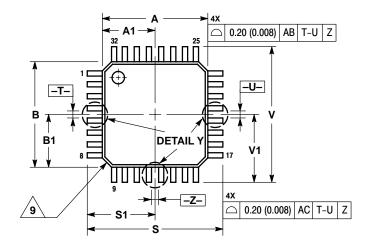
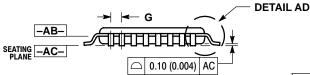


Figure 4. Typical Termination for Output Driver and Device Evaluation

# PACKAGE DIMENSIONS







R

K

X

Q

0.250 (0.010) GAUGE PLANE

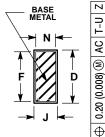
8X M

w

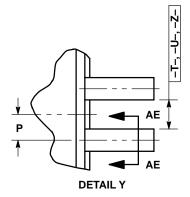
DETAIL AD

Ε С

Н



SECTION AE-AE



- NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: MILLIMETER.
- 2. DATUM PLANE -AB- IS LOCATED AT BOTTOM OF LEAD AND IS COINCIDENT WITH THE LEAD
- 4.
- 5.
- LEAD AND IS COINCIDENT WITH THE LEAD WHERE THE LEAD EXITS THE PLASTIC BODY AT THE BOTTOM OF THE PARTING LINE. DATUMS -T-, -U-, AND -Z- TO BE DETERMINED AT DATUM PLANE -AB-. DIMENSIONS S AND V TO BE DETERMINED AT SEATING PLANE -AC-. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.250 (0.010) PER SIDE. DIMENSIONS A AND B DO INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE -AB-. DIMENSION D DOES NOT INCLUDE AMBAR 6.
- 8. MINIMUM SOLDER PLATE THICKNESS SHALL BE
- 0.0076 (0.0003). 9. EXACT SHAPE OF EACH CORNER MAY VARY FROM DEPICTION.

	MILLIN	IETERS	INC	HES			
DIM	M MIN MAX		MIN	MAX			
Α	7.000	BSC	0.276	BSC BSC			
A1	3.500	BSC	0.138	BSC 3			
В	7.000	BSC	0.276 BSC				
B1	3.500	BSC	0.138	BSC			
С	1.400	1.600	0.055	0.063			
D	0.300	0.450	0.012	0.018			
E	1.350	1.450	0.053	0.057			
F	0.300	0.400	0.012	0.016			
G	0.800	BSC	0.031	BSC			
н	0.050	0.150	0.002	0.006			
J	0.090	0.200	0.004	0.008			
K	0.500	0.700	0.020	0.028			
Μ	12°	REF	12°	REF			
N	0.090	0.160	0.004	0.006			
Р	0.400	BSC	0.016	BSC			
Q	1°	5°	1°	5 °			
R	0.150	0.250	0.006	0.010			
S	9.000	BSC	0.354 BSC				
S1	4.500 BSC		0.177 BSC				
v	9.000 BSC		0.354 BSC				
V1	4.500 BSC		0.177 BSC				
W	0.200	REF	0.008 REF				
X	1.000	REF	0.039 REF				

# <u>Notes</u>

# <u>Notes</u>

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